

3-of-8 Decoder/Demultiplexer

74VHC138

General Description

The VHC138 is an advanced high speed CMOS 3-to-8 decoder/demultiplexer fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

When the device is enabled, 3 binary select inputs (A_0 , A_1 and A_2) determine which one of the outputs ($\bar{O}_0$ – $\bar{O}_7$) will go LOW. When enable input E_3 is held LOW or either $\bar{E}_1$ or $\bar{E}_2$ is held HIGH, decoding function is inhibited and all outputs go HIGH. E_3 , $\bar{E}_1$ and $\bar{E}_2$ inputs are provided to ease cascade connection and for use as an address decoder for memory systems. An input protection circuit ensures that 0 V to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High Speed: $t_{PD} = 5.7$ ns (Typ) at $T_A = 25^\circ\text{C}$
- Low Power Dissipation: $I_{CC} = 4$ μA (Max.) at $T_A = 25^\circ\text{C}$
- High Noise Immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (Min.)
- Power Down Protection Provided on All Inputs
- Pin and Function Compatible with 74HC138
- These Devices are Pb-Free and are RoHS Compliant

Logic Symbols

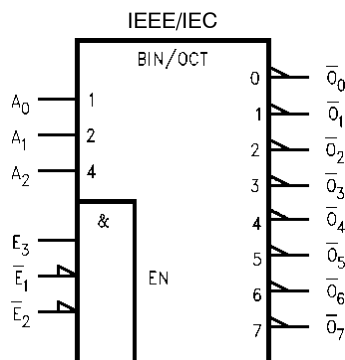
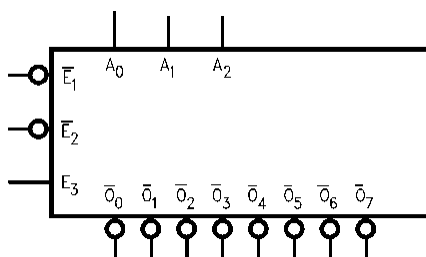
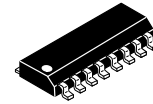
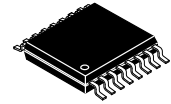


Figure 1. Logic Symbols

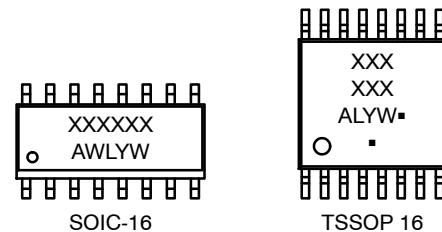


SOIC-16, 150 mils
CASE 751BG



TSSOP 16
CASE 948AH

MARKING DIAGRAMS



XXXXXX = Specific Device Code

A = Assembly Location

WL, L = Wafer Lot

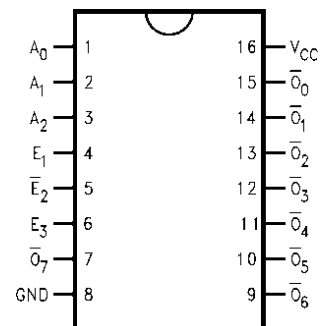
Y = Year

WW, W = Work Week

G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

CONNECTION DIAGRAM



PIN DESCRIPTIONS

Pins	Function
A_0 – A_2	Address Inputs
E_1 – E_2	Enable Inputs
E_3	Enable Input
$\bar{O}_0$ – $\bar{O}_7$	Outputs

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

TRUTH TABLE

Inputs						Outputs							
$\overline{E}_1$	$\overline{E}_2$	$\overline{E}_3$	A_0	A_1	A_2	$\overline{O}_0$	$\overline{O}_1$	$\overline{O}_2$	$\overline{O}_3$	$\overline{O}_4$	$\overline{O}_5$	$\overline{O}_6$	$\overline{O}_7$
H	X	X	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	X	H	H	H	H	H	H	H	H
X	X	L	X	X	X	H	H	H	H	H	H	H	H
L	L	H	L	L	L	L	H	H	H	H	H	H	H
L	L	H	H	L	L	H	L	H	H	H	H	H	H
L	L	H	L	H	L	H	H	L	H	H	H	H	H
L	L	H	H	H	L	H	H	H	L	H	H	H	H
L	L	H	L	L	H	H	H	H	H	L	H	H	H
L	L	H	H	L	H	H	H	H	H	H	L	H	H
L	L	H	L	H	H	H	H	H	H	H	H	L	H
L	L	H	H	H	H	H	H	H	H	H	H	H	L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	-0.5 to +6.5	V
V_{IN}	DC Input Voltage	-0.5 to +6.5	V
V_{OUT}	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IN}	DC Input Current, per Pin	± 20	mA
I_{OUT}	DC Output Current, per Pin	± 25	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	± 75	mA
I_{IK}	Input Clamp Current	-20	mA
I_{OK}	Output Clamp Current	± 20	mA
T_{STG}	Storage Temperature Range	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C
T_J	Junction Temperature Under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC-16 TSSOP 16 126 159	°C/W
P_D	Power Dissipation in Still Air at 25 °C	SOIC-16 TSSOP 16 995 787	mW
MSL	Moisture Sensitivity	Level 1	
F_R	Flammability Rating	Oxygen Index: 28 to 34 UL 94 V-0 @ 0.138 in	
V_{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model 2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.
2. Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.
3. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage	2.0	5.5	V
V _{IN}	DC Input Voltage (Note 4)	0	5.5	V
V _{OUT}	DC Output Voltage (Note 4)	0	V _{CC}	V
T _A	Operating Temperature	−40	+85	°C
t _r , t _f	Input Rise and Fall Time	V _{CC} = 3.0 V to 3.6 V V _{CC} = 4.5 V to 5.5 V	0 100 20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions		V _{CC} (V)	T _A = 25 °C			T _A = −40 °C to 85 °C		Unit
					Min	Typ	Max	Min	Max	
V _{IH}	HIGH Level Input Voltage			2.0 3.0–5.5	1.50 0.7 V _{CC}	– –	– –	1.50 0.7 V _{CC}	– –	V
V _{IL}	LOW Level Input Voltage			2.0 3.0–5.5	– –	– –	0.50 0.3 V _{CC}	– –	0.50 0.3 V _{CC}	V
V _{OH}	HIGH Level Output Voltage	V _{IN} = V _{IH} or V _{IL}	I _{OH} = −50 μA	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	– – –	1.9 2.9 4.4	– – –	V
			I _{OH} = −4 mA I _{OH} = −8 mA	3.0 4.5	2.58 3.94	– –	– –	2.48 3.80	– –	V
V _{OL}	LOW Level Output Voltage	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0 3.0 4.5	– – –	0.0 0.0 0.0	0.1 0.1 0.1	– – –	0.1 0.1 0.1	V
			I _{OL} = 4 mA I _{OL} = 8 mA	3.0 4.5	– –	– –	0.36 0.36	– –	0.44 0.44	V
I _{IN}	Input Leakage Current	V _{IN} = 5.5 V or GND		0–5.5	–	–	±0.1	–	±1.0	μA
I _{CC}	Quiescent Supply Current	V _{IN} = V _{CC} or GND		5.5	–	–	4.0	–	40.0	μA



74VHC138

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = 25 °C			T _A = -40 °C to 85 °C		Unit
				Min	Typ	Max	Min	Max	
t _{PLH} , t _{PHL}	Propagation Delay A _n to $\bar{O}_n$	C _L = 15 pF	3.3 ±0.3	–	8.2	11.4	1.0	13.5	ns
		C _L = 50 pF		–	10.0	15.8	1.0	18.0	
		C _L = 15 pF	5.0 ±0.5	–	5.7	8.1	1.0	9.5	ns
		C _L = 50 pF		–	7.2	10.1	1.0	11.5	
t _{PLH} , t _{PHL}	Propagation Delay E ₃ to $\bar{O}_n$	C _L = 15 pF	3.3 ±0.3	–	8.1	12.8	1.0	15.0	ns
		C _L = 50 pF		–	10.6	16.3	1.0	18.5	
		C _L = 15 pF	5.0 ±0.5	–	5.6	8.1	1.0	9.5	ns
		C _L = 50 pF		–	7.1	10.1	1.0	11.5	
t _{PLH} , t _{PHL}	Propagation Delay $\bar{E}_1$ or $\bar{E}_2$ to $\bar{O}_n$	C _L = 15 pF	3.3 ±0.3	–	8.2	11.4	1.0	13.5	ns
		C _L = 50 pF		–	10.7	14.9	1.0	17.0	
		C _L = 15 pF	5.0 ±0.5	–	5.8	8.1	1.0	9.5	ns
		C _L = 50 pF		–	7.3	10.1	1.0	11.5	
C _{IN}	Input Capacitance	V _{CC} = Open	–	–	4	10	–	10	pF
C _{PD}	Power Dissipation Capacitance	(Note 5)	–	–	34	–	–	–	pF

5. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC} (opr.) = C_{PD} × V_{CC} × f_{IN} + I_{CC}.

ORDERING INFORMATION

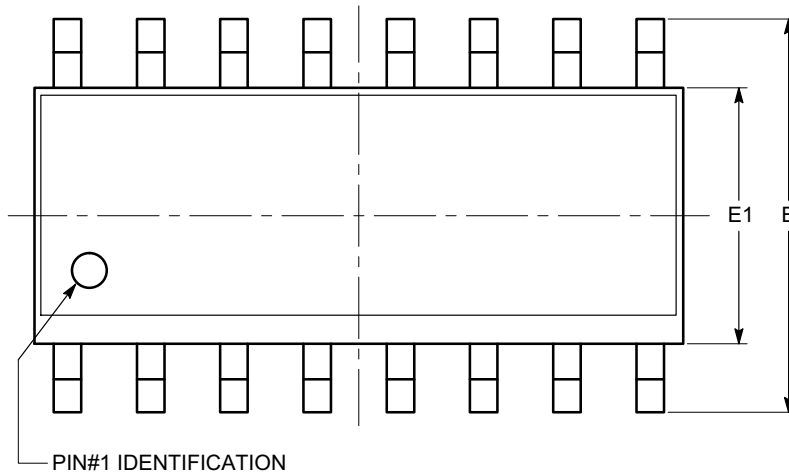
Device	Marking	Package	Shipping [†]
74VHC138MX	VHC138G	SOIC-16 (Pb-Free)	2500 Tape & Reel
74VHC138MTCX	VHC 138	TSSOP 16 (Pb-Free)	2500 Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



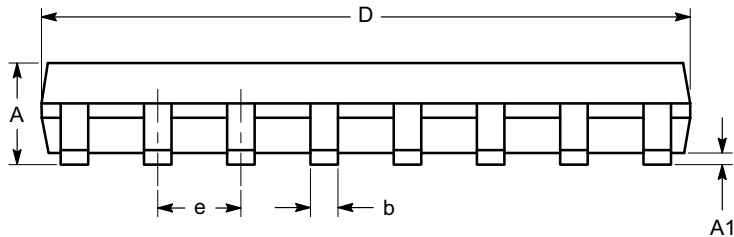
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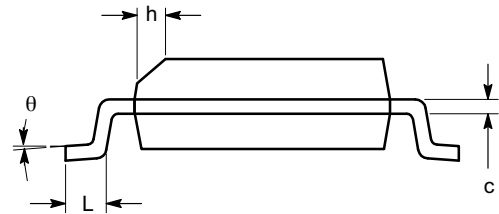


SYMBOL	MIN	NOM	MAX
A	1.35		1.75
A1	0.10		0.25
b	0.33		0.51
c	0.19		0.25
D	9.80	9.90	10.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27 BSC		
h	0.25		0.50
L	0.40		1.27
θ	0°		8°

TOP VIEW



SIDE VIEW



END VIEW

Notes:

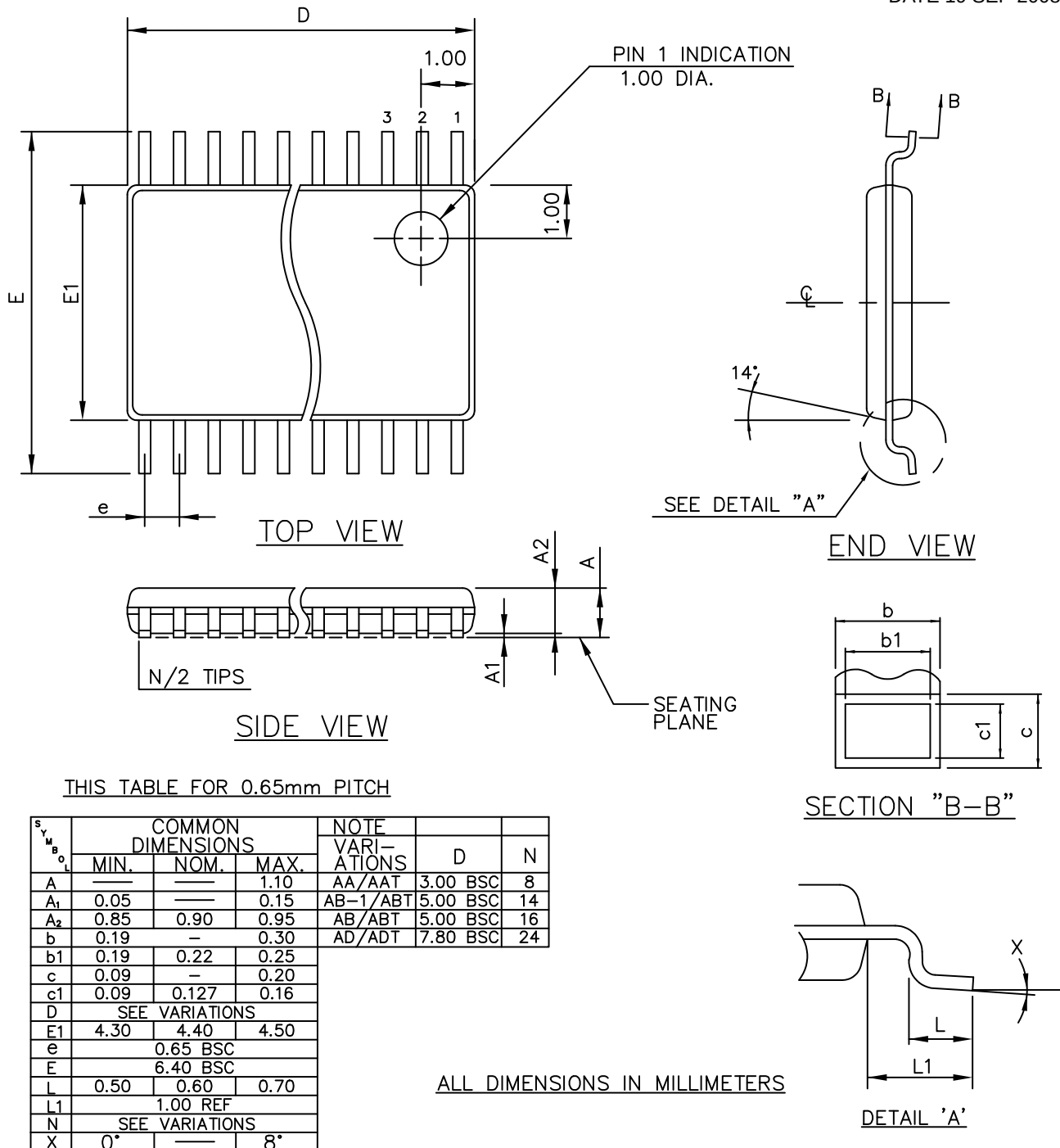
- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-012.

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